# **Tyrone Camarero Specifications**

# **Tyrone**

### Camarero IDI100C2R-14

#### **Key features**

- 3rd Generation Intel® Xeon® Scalable Processors , 270 W
- Intel® C621A Chipset
- DDR4 (RDIMM), 3DS-RDIMM, Load Reduced DDR4 (LRDIMM),3DS-LRDIMM, Intel® Optane™ persistent memory 200 series, Max Memory Size (dependent on memory type) 12 TB
- Riser Slot 1: Lanes 16, Riser Slot 2: Lanes 24, Riser Slot 3: Lanes 16
- 4 Hot-Swap 2.5"" SSD
- 10 SATA Ports, RAID 0/1/5/10, 8 Integrated SAS Ports
- Three USB 3.0 on the back panel, One USB 3.0 + one USB 2.0 on the front panel, One USB 2.0 internal Type-A
- 1300 W Redundant Power Supply
- 1U Rackmount





#### Processor/Cache

Processor 3rd

3rd Generation Intel® Xeon® Scalable

Processors, 270 W

Chipset

Chipset

Intel® C621A

#### System Memory

**Memory Capacity** 

DDR4 (RDIMM), 3DS-RDIMM, Load Reduced DDR4 (LRDIMM), 3DS-LRDIMM, Intel® Optane™ persistent memory 200 series, Max Memory Size (dependent on memory type) 12 TB

#### **Expansion Slots**

**PCI-Express** 

Riser Slot 1: Lanes 16, Riser Slot 2: Lanes 24, Riser Slot 3: Lanes 16

#### **Integrated Onboard**

SATA

10 SATA Ports, RAID 0/1/5/10, 8 Integrated

SAS Ports

USB

Three USB 3.0 on the back panel, One USB 3.0 + one USB 2.0 on the front panel, One

USB 2.0 internal Type-A

#### **Add-on Options**

Optical Drive:

None

## **Drive Bays**

**HDD Bays** 

4 Hot-Swap 2.5"" SSD

#### **Power Supply**

1300 W Redundant Power Supply

#### **Form Factor**

Form Factor

1U Rackmount

Dimensions

781 x 438 x 43 mm

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For more/current product information, visit

www.tyronesystems.com

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